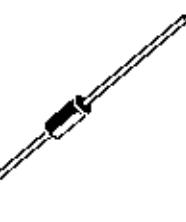


TRIGGER DIODES

FEATURES

- V_{BO} : 32V / 34V / 40V VERSIONS
- LOW BREAKOVER CURRENT



DO 35
(Glass)

DESCRIPTION

High reliability glass passivation insuring parameter stability and protection against junction contamination.

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
P	Power dissipation on printed circuit (L = 10 mm)	T _a = 65 °C	150	mW
I _{TRM}	Repetitive peak on-state current	t _p = 20 µs F = 100 Hz	2	A
T _{stg} T _j	Storage and operating junction temperature range		- 40 to + 125 - 40 to + 125	°C °C

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R _{th} (j-a)	Junction to ambient	400	°C/W
R _{th} (j-l)	Junction-leads	150	°C/W

DB3 / DB4 / DC34

ELECTRICAL CHARACTERISTICS ($T_j = 25^\circ\text{C}$)

Symbol	Parameter	Test Conditions		Value			Unit
				DB3	DC34	DB4	
V_{BO}	Breakover voltage *	$C = 22\text{nF}^{**}$ see diagram 1	MIN	28	30	35	V
			TYP	32	34	40	
			MAX	36	38	45	
$[I + V_{BO}] - I - V_{BO}]$	Breakover voltage symmetry	$C = 22\text{nF}^{**}$ see diagram 1	MAX	± 3			V
$I \Delta V \pm I$	Dynamic breakover voltage *	$\Delta I = [I_{BO} \text{ to } I_F = 10\text{mA}]$ see diagram 1	MIN	5			V
V_O	Output voltage *	see diagram 2	MIN	5			V
I_{BO}	Breakover current *	$C = 22\text{nF}^{**}$	MAX	100	50	100	μA
t_r	Rise time *	see diagram 3	TYP	1.5			μs
I_B	Leakage current *	$V_B = 0.5 V_{BO} \text{ max}$ see diagram 1	MAX	10			μA

* Electrical characteristic applicable in both forward and reverse directions.

** Connected in parallel with the devices.

DIAGRAM 1 : Current-voltage characteristics

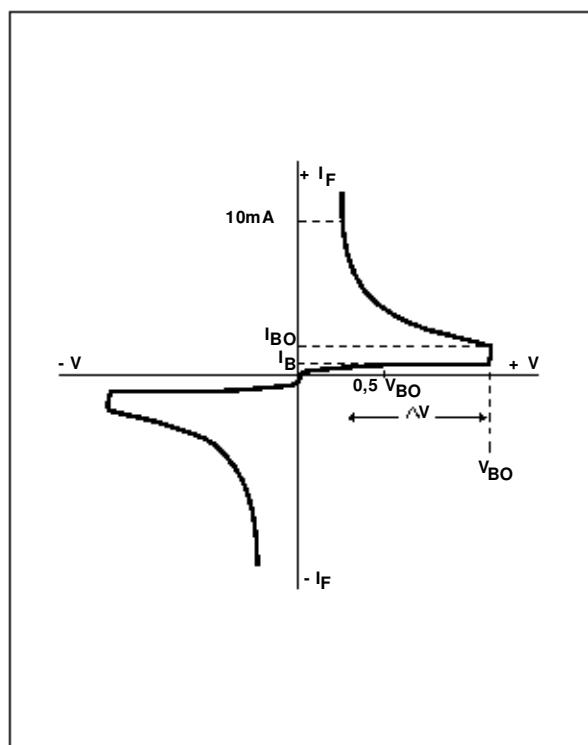
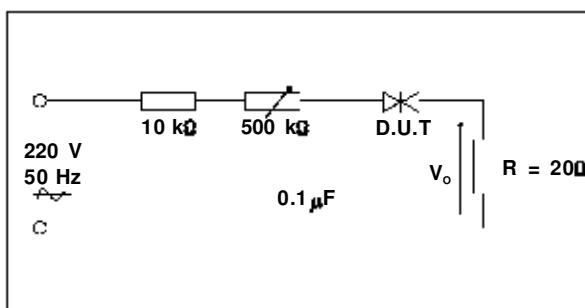


DIAGRAM 2 : Test circuit for output voltage



**DIAGRAM 3 : Test circuit see diagram 2.
Adjust R for $I_p = 0.5\text{A}$**

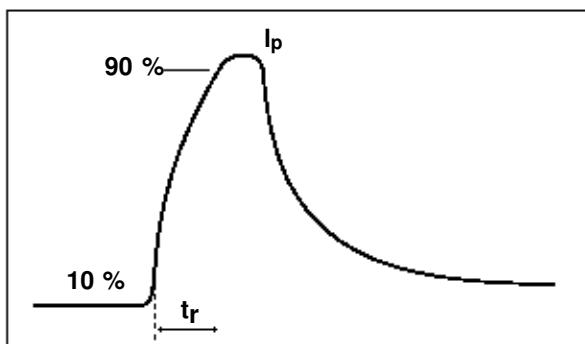


Fig.1 : Power dissipation versus ambient temperature (maximum values)

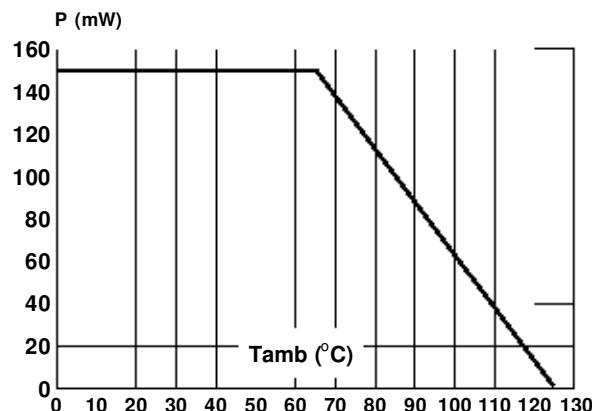


Fig.2 : Relative variation of V_{BO} versus junction temperature (typical values)

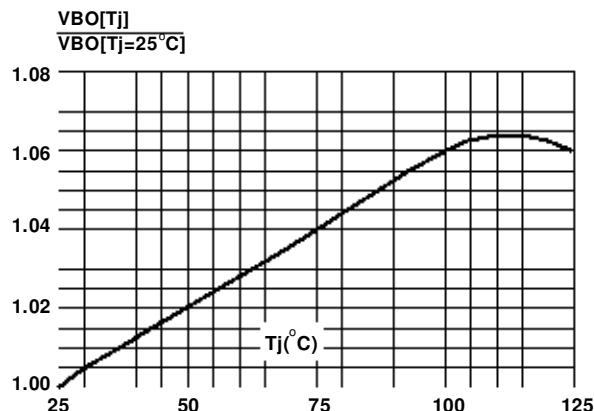
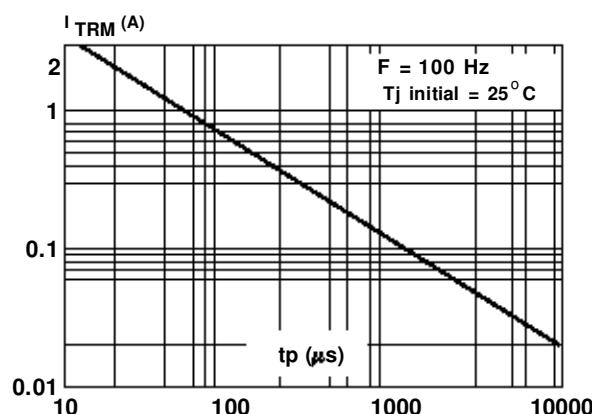


Fig.3 : Peak pulse current versus pulse duration (maximum values)



DB3 / DB4 / DC34

PACKAGE MECHANICAL DATA (in millimeters)

DO 35 Glass

REF.	DIMENSIONS				NOTES	
	Millimeters		Inches			
	Min.	Max.	Min.	Max.		
A	3.050	4.500	0.120	0.117	1 - The lead diameter \varnothing D is not controlled over zone E 2 - The minimum axial length within which the device may be placed with its leads bent at right angles is 0.59"(15 mm)	
B	12.7		0.500			
\varnothing C	1.530	2.000	0.060	0.079		
\varnothing D	0.458	0.558	0.018	0.022		
E		1.27		0.050		

Cooling method by convection and conduction

Marking : type number

Weight : 0.15 g

Polarity : N A

Stud torque : N A

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